# MMBFJ309L, MMBFJ310L, SMMBFJ309L, SMMBFJ310L

# JFET - VHF/UHF Amplifier Transistor

# **N–Channel**

#### Features

- Drain and Source are Interchangeable
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### MAXIMUM RATINGS

| Rating               | Symbol          | Value | Unit |
|----------------------|-----------------|-------|------|
| Drain-Source Voltage | V <sub>DS</sub> | 25    | Vdc  |
| Gate-Source Voltage  | V <sub>GS</sub> | 25    | Vdc  |
| Gate Current         | I <sub>G</sub>  | 10    | mAdc |

#### THERMAL CHARACTERISTICS

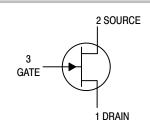
| Characteristic  | Symbol                            | Max         | Unit        |
|---|-----------------------------------|-------------|-------------|
| Total Device Dissipation FR–5 Board,<br>(Note 1) T <sub>A</sub> = 25°C<br>Derate above 25°C | P <sub>D</sub>                    | 225<br>1.8  | mW<br>mW/°C |
| Thermal Resistance, Junction-to-Ambient   | $R_{\thetaJA}$                    | 556         | °C/W        |
| Junction and Storage Temperature  | T <sub>J</sub> , T <sub>stg</sub> | -55 to +150 | °C          |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. FR-5 =  $1.0 \times 0.75 \times 0.062$  in.



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SOT-23 (TO-236) CASE 318 STYLE 10

#### MARKING DIAGRAM



6x = Device Code

- x = U for MMBFJ309L, SMMBFJ309L
- x = T for MMBFJ310L, SMMBFJ310L
- M = Date Code\*

= Pb–Free Package

(Note: Microdot may be in either location) \*Date Code orientation and/or overbar may vary depending upon manufacturing location.

#### **ORDERING INFORMATION**

| Device        | Package             | Shipping <sup>†</sup>   |
|---------------|---------------------|-------------------------|
| MMBFJ309LT1G, | SOT-23              | 3,000 / Tape &          |
| SMMBFJ309LT1G | (Pb-Free)           | Reel                    |
| MMBFJ310LT1G, | SOT-23              | 3,000 / Tape &          |
| SMMBFJ310LT1G | (Pb-Free)           | Reel                    |
| SMMBFJ310LT3G | SOT-23<br>(Pb-Free) | 10,000 / Tape &<br>Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

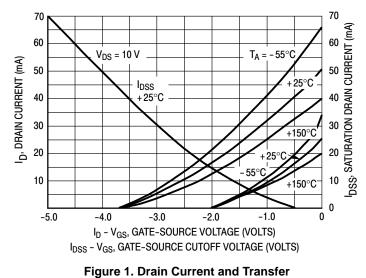
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## **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

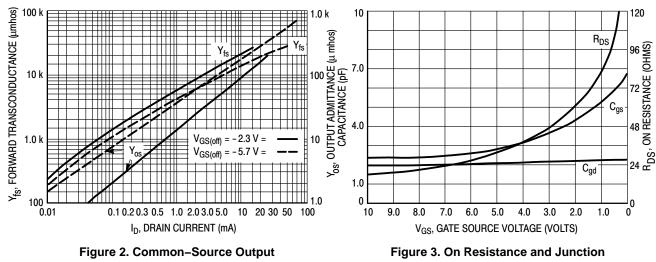
| Characteristic  |                                 | Symbol               | Min          | Тур | Max          | Unit           |
|---|---------------------------------|----------------------|--------------|-----|--------------|----------------|
| OFF CHARACTERISTICS   |                                 |                      |              |     |              |                |
| Gate–Source Breakdown Voltage $(I_G = -1.0 \ \mu Adc, \ V_{DS} = 0)$  |                                 | V <sub>(BR)GSS</sub> | -25          | -   | -            | Vdc            |
| Gate Reverse Current ( $V_{GS} = -15$ Vdc)<br>( $V_{GS} = -15$ Vdc, $T_A = 125^{\circ}C$ )                          |                                 | I <sub>GSS</sub>     | -            | -   | -1.0<br>-1.0 | nAdc<br>μAdc   |
| Gate Source Cutoff Voltage $(V_{DS} = 10 \text{ Vdc}, I_D = 1.0 \text{ nAdc})$                                      | MMBFJ309<br>MMBFJ310, SMMBFJ310 | V <sub>GS(off)</sub> | -1.0<br>-2.0 | -   | -4.0<br>-6.5 | Vdc            |
| ON CHARACTERISTICS  |                                 |                      |              |     |              |                |
| Zero–Gate–Voltage Drain Current $(V_{DS} = 10 \text{ Vdc}, V_{GS} = 0)$   | MMBFJ309<br>MMBFJ310, SMMBFJ310 | I <sub>DSS</sub>     | 12<br>24     |     | 30<br>60     | mAdc           |
| Gate-Source Forward Voltage $(I_G = 1.0 \text{ mAdc}, V_{DS} = 0)$  |                                 | V <sub>GS(f)</sub>   | -            | -   | 1.0          | Vdc            |
| SMALL-SIGNAL CHARACTERISTICS  |                                 |                      |              |     |              |                |
| Forward Transfer Admittance $(V_{DS} = 10 \text{ Vdc}, I_D = 10 \text{ mAdc}, f = 1.0 \text{ kHz})$                 |                                 | Y <sub>fs</sub>      | 8.0          | -   | 18           | mmhos          |
| Output Admittance $(V_{DS} = 10 \text{ Vdc}, I_D = 10 \text{ mAdc}, f = 1.0 \text{ kHz})$                           |                                 | y <sub>os</sub>      | -            | _   | 250          | μmhos          |
| Input Capacitance<br>(V <sub>GS</sub> = -10 Vdc, V <sub>DS</sub> = 0 Vdc, f = 1.0 MHz)                              |                                 | C <sub>iss</sub>     | -            | -   | 5.0          | pF             |
| Reverse Transfer Capacitance $(V_{GS} = -10 \text{ Vdc}, V_{DS} = 0 \text{ Vdc}, f = 1.0 \text{ MHz})$              |                                 | C <sub>rss</sub>     | -            | -   | 2.5          | pF             |
| Equivalent Short–Circuit Input Noise Voltage $(V_{DS} = 10 \text{ Vdc}, I_D = 10 \text{ mAdc}, f = 100 \text{ Hz})$ |                                 | e <sub>n</sub>       | -            | 10  | _            | $nV/\sqrt{Hz}$ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

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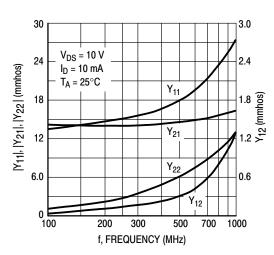
Characteristics versus Gate–Source Voltage



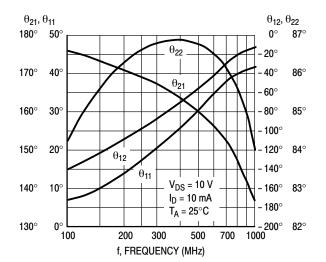
Admittance and Forward Transconductance versus Drain Current

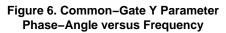
Capacitance versus Gate-Source Voltage

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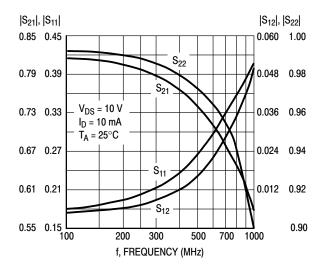
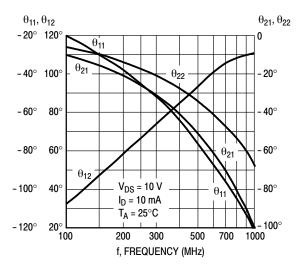
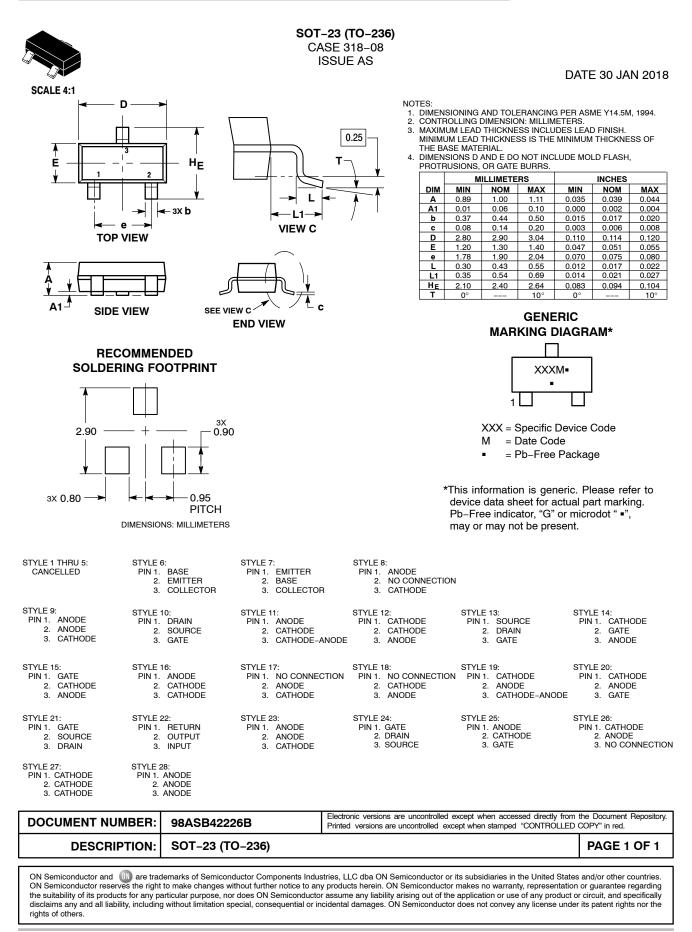


Figure 5. Common–Gate S Parameter Magnitude versus Frequency









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